

# **Step Recovery Diode Chips**

## Technical Data

5082-0008 5082-0015 5082-0017 5082-0018 5082-0020 5082-0032

#### **Features**

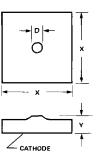
- Optimized for Both Low and High Order Multiplier Designs from UHF through Ku Band
- Passivated Chip for Maximum Stability and Reliability
- Gold Top Contact for Long Shelf Life and Bondability

#### Description

These diodes are manufactured using modern epitaxial growth techniques. The diodes are passivated with a thermal oxide for maximum stability. The result is a family of devices offering highly repeatable, efficient and reliable performance. Both the anode and cathode contact metallizations are gold allowing long shelf life and repeatable bondability. These diodes are designed to meet the general requirements of MIL-S-19500.

### **Applications**

These Step Recovery Diodes are intended for medium and low power multipliers. Typical applications are in hybrid local oscillators, especially where low phase noise is required, in terrestrial communications,



Outline 01B

Dimen- sion	5082-									
	0020	8000	0015	0017	0018	0021	0032	0090		
D	0.13 (5)	0.06	0.15 (6)	0.39 (15.5)	0.05	0.22 (8.5)	0.32	0.15		
Х	0.38	0.38	0.38	0.64 (25)	0.38 (15)	0.51 (20)	0.51 (20)	0.38		
Υ	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)	0.11 (4.5)		

DIMENSIONS IN MILLIMETERS (1/1000 inch)

satellite communications, TVRO, mobile communications and test equipment. Input frequencies extend down to 10 MHz with output frequencies through 40 GHz.

### **Maximum Ratings**

Junction Operating and Storage
Temperature Range .....-60°C to +200°C
Maximum Die Attach Temperature .....+310°C for 1 minute

# Electrical Specifications at $T_A = 25^{\circ}C$

				·		
 	Minimum	Typical	Typical Lifetime τ (ns) <sup>[3]</sup>	Typical Trans	Nearest	
Part Number 5082-	Breakdown Voltage V <sub>BR</sub> (V) <sup>[1]</sup>	Chip Capacitance C <sub>j</sub> (pF) <sup>[2]</sup>		Transition Time t <sub>t</sub> (ps)	Charge Level (pc)	Equivalent Packaged Part No. 5082-
0008	15	0.38	20	60	100	0835
0018	25	0.5	20	70	200	0253
0020	25	0.8	20	60	300	0830
0015	35	1.2	60	150	1000	0132
0032	50	4.0	150	250	1500	0241
0017	75	4.0	300	300	2400	0300

#### Notes:

- 1. Minimum Breakdown Voltage test condition is  $I_R=10~\mu A$ . 2. Capacitance sample test condition is  $V_R=10~V$  and f=1~MHz. 3. Lifetime sample test condition is  $I_F=10~mA$  and  $I_R=6~mA$ .